

## **Product Bulletin**

Document # : PB20824A Issue Date: 9 April 2015

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Title of Change:	LC05111CMT Datasheet Update	
Proposed first ship date:	9 April 2015	
Contact information:	Contact your local ON Semiconductor Sales Office or Hiroshi Saito < Hiroshi2.Saito@onsemi.com>	
Type of notification:	ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>	
Change category(s):  Wafer Fab Change Assembly Change Test Change	☐ Manufacturing Site Change/Addition☐ Manufacturing Process Change☐ Material Change	<ul><li>□ Product specific change</li><li>□ Datasheet/Product Doc change</li><li>□ Shipping/Packaging/Marking</li><li>□ Other:</li></ul>
Sites Affected:  ☐ All site(s) ☐ not applicable ☐ ON Semiconductor site(s): ☐ External Foundry/Subcon site		Site 2
<ul> <li>Change in "Pdmax" and Pdmax-Ta graph. Change the maximum Pdmax from 350mW to 450mW.</li> <li>Package dimensions update - L3 value added. No impact to customer design.</li> <li>Added LC05111C12MT in selection guide</li> </ul>		
List of affected Standard Parts:  LC05111C01MTTTG LC05111C03MTTTG LC05111C04MTTTG LC05111C05MTTTG LC05111C05MTTTG LC05111C06MTTTG LC05111C07MTTTG LC05111C09MTTTG LC05111C09MTTTG LC05111C19MTTTG LC05111C19MTTTG LC05111C10MTTTG LC05111C11MTTTG LC05111C11MTTTG		

TEM001094 Rev. D Page 1 of 1